



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A
Supplier Information									
Company Name	TE Connectivity	Request Document ID		Contact Name	Benfer David W	Contact Title	Product Compliance Engineer for DND		
Company Unique ID	TE Connectivity	Response Date	2018-04-03	Contact Email	dave.benfer@te.com				
Contact Phone Number	717-986-3725								
Legal Statement									
Supplier Acceptance	true								
Legal Statement									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
Product									
Manufacturer Item number	1487595-2	Amount	54738.41907886	Version	-	Identity			
Manufacturer Item Name	USB, A-B, 28/26, BLACK, 1.3M	Weight Uom	mg	Mfr Site		Authority			
Date		UOM	Each						
EUroHS-0508	Product(s) meets EU RoHS requirement without any exemptions								
ChinaRoHS-0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
EUREACH-0117	REACH Candidate Substances of Very High Concern ARE NOT Yet Reviewed								
Complex Article Description	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
Product Disclosure									
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Sub-Item	1	COPER FOIL TAPE 6W				1.0	100.12473193	mg	
Material	2	Glue				1.0	13.77716311	mg	
Substance	3	2-Propenoic acid, homopolymer	Supplier	9003-01-4	100.0	1.0	13.77716	mg	
Material	2	Copper				1.0	86.34756882	mg	
Substance	3	Iron	Supplier	7439-89-6	0.05	1.0	0.04317378	mg	
Substance	3	Copper	Supplier	7440-50-8	99.9	1.0	86.26122	mg	
Substance	3	Zinc	Supplier	7440-66-6	0.05	1.0	0.04317378	mg	
Sub-Item	1	Other Consumer Cable Assy's				1.0	12000.0	mg	
Material	2	MOLDED BLOCK				1.0	12000.0	mg	
Substance	3	Carbonic acid calcium salt (1:1)	Supplier	471-34-1	22.81	1.0	2737.2	mg	
Substance	3	Antimony oxide	Supplier	1327-33-9	0.73	1.0	87.6	mg	
Substance	3	Ethene, chloro-, homopolymer	Supplier	9002-86-2	51.86	1.0	6223.2	mg	
Substance	3	Octadecanoic acid, calcium salt (2:1)	Supplier	1592-23-0	3.11	1.0	373.2	mg	
Substance	3	Ethene, homopolymer	Supplier	9002-88-4	0.73	1.0	87.6	mg	
Substance	3	1,2,4-Benzenetricarboxylic acid, 1,2,4-tris(2-ethylhexyl) ester	Supplier	3319-31-1	18.68	1.0	2241.6	mg	
Substance	3	Soybean oil, epoxidized	Supplier	8013-07-8	2.08	1.0	249.6	mg	
Sub-Item	1	USB 4P GOLD 30U B TYPE				1.0	4200.0	mg	
Material	2	Shell				1.0	2832.4	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.19	1.0	5.38156	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	0.018	1.0	0.50983	mg	
Substance	3	Carbon	Supplier	7440-44-0	0.0030	1.0	0.084972	mg	
Substance	3	Sulfur	Supplier	7704-34-9	0.012	1.0	0.33989	mg	

Substance	3	Iron	Supplier	7439-89-6	99.777	1.0	2826.08375	mg	
Material	2	Shell-Ni plating				1.0	0.6	mg	
Substance	3	Nickel	Nickel	7440-02-0	100.0	1.0	0.6	mg	
Material	2	Contact				1.0	366.4	mg	
Substance	3	Copper	Supplier	7440-50-8	65.14	1.0	238.67296	mg	
Substance	3	Iron	Supplier	7439-89-6	0.0070	1.0	0.025648	mg	
Substance	3	Zinc	Supplier	7440-66-6	34.851	1.0	127.69406	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0020	1.0	0.007328	mg	
Material	2	Housing				1.0	1000.0	mg	
Substance	3	1,4-Benzenedicarboxylic acid, 1,4-dimethyl ester, polymer with 1,4-butanediol	Supplier	30965-26-5	43.0	1.0	430.0	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	30.0	1.0	300.0	mg	
Substance	3	Antimony oxide (Sb2O3)	Supplier	1309-64-4	7.0	1.0	70.0	mg	
Substance	3	Phenol, 4,4-(1-methylethylidene)bis[2,6-dibromo-polymer with 2,2-[(1-methylethylidene)bis(2,6-dibromo-4,1-phenylene)oxy methylene]]bis[oxirane]	Supplier	68928-70-1	20.0	1.0	200.0	mg	
Material	2	Contact-Au plating				1.0	0.3	mg	
Substance	3	Gold	Supplier	7440-57-5	100.0	1.0	0.3	mg	
Material	2	Contact-Pd-Ni plating				1.0	0.3	mg	
Substance	3	Nickel	Nickel	7440-02-0	20.0	1.0	0.06	mg	
Substance	3	Palladium	Supplier	7440-05-3	80.0	1.0	0.24	mg	
Sub-Item	1	SOLDER WIRE, LEAD-FREE, SN99.3 CU0.7% 0.8				1.0	200.0	mg	
Material	2	Solder wire				1.0	200.0	mg	
Substance	3	Copper	Supplier	7440-50-8	0.7	1.0	1.4	mg	
Substance	3	Tin	Supplier	7440-31-5	99.3	1.0	198.6	mg	
Sub-Item	1	USB 2.0 CBL 1P*28#+2C*26 # BK01				1.0	33958.29434693	mg	
Material	2	Insulation				1.0	15935.95041912	mg	
Substance	3	Antimony oxide (Sb2O3)	Supplier	1309-64-4	1.65	1.0	262.94318	mg	
Substance	3	Carbonic acid calcium salt (1:1)	Supplier	471-34-1	24.81	1.0	3953.7093	mg	
Substance	3	Octadecanoic acid, zinc salt (2:1)	Supplier	557-05-1	2.47	1.0	393.61798	mg	
Substance	3	Ethene, chloro-, homopolymer	Supplier	9002-86-2	41.41	1.0	6599.07707	mg	
Substance	3	1,2-Benzenedicarboxylic acid, 1,2-diisononyl ester	Phthalates (DINP, DIDP, DNOP)	28553-12-0	29.66	1.0	4726.60289	mg	
Material	2	HD-PE				1.0	1331.1958583	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	1.0	1.0	13.31196	mg	
Substance	3	Ethene, homopolymer	Supplier	9002-88-4	99.0	1.0	1317.8839	mg	
Material	2	Jacket				1.0	2329.59275203	mg	
Substance	3	Antimony oxide (Sb2O3)	Supplier	1309-64-4	1.65	1.0	38.43828	mg	
Substance	3	Ethene, chloro-, homopolymer	Supplier	9002-86-2	41.41	1.0	964.68436	mg	
Substance	3	Carbonic acid calcium salt (1:1)	Supplier	471-34-1	24.81	1.0	577.97196	mg	
Substance	3	Octadecanoic acid, zinc salt (2:1)	Supplier	557-05-1	2.47	1.0	57.54094	mg	

Substance	3	1,2-Benzenedicarb oxylic acid, 1,2- diisononyl ester	Phthalates (DINP, DIDP, DNOP)	28553-12-0	29.66	1.0	690.95721	mg	
Material	2	Al/PET				1.0	767.99761056	mg	
Substance	3	Acetic acid ethyl ester	Supplier	141-78-6	0.1	1.0	0.768	mg	
Substance	3	Aluminum	Supplier	7429-90-5	60.0	1.0	460.79857	mg	
Substance	3	Poly(oxy-1,2- ethanediylloxyc arbonyl-1,4- phenylenecarb onyl)	Supplier	25038-59-9	35.0	1.0	268.79916	mg	
Substance	3	1,2-Ethenediol	Supplier	107-21-1	4.8	1.0	36.86389	mg	
Substance	3	2- Methylpentane- 2,4-diol	Supplier	107-41-5	0.1	1.0	0.768	mg	
Material	2	Conductor				1.0	13593.557706 91	mg	
Substance	3	Tin	Supplier	7440-31-5	2.0	1.0	271.87115	mg	
Substance	3	Copper	Supplier	7440-50-8	98.0	1.0	13321.68655	mg	
Sub-Item	1	SOLDER BAR,Sn99.3/C u0.7				1.0	150.0	mg	
Material	2	Solder Bar				1.0	150.0	mg	
Substance	3	Tin	Supplier	7440-31-5	99.3	1.0	148.95	mg	
Substance	3	Copper	Supplier	7440-50-8	0.7	1.0	1.05	mg	
Sub-Item	1	USB A TYPE 4PIN MALE GOLD30U				1.0	4080.0	mg	
Material	2	Shell				1.0	3549.4	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.19	1.0	6.74386	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	0.018	1.0	0.63889	mg	
Substance	3	Carbon	Supplier	7440-44-0	0.0030	1.0	0.10648	mg	
Substance	3	Sulfur	Supplier	7704-34-9	0.012	1.0	0.42593	mg	
Substance	3	Iron	Supplier	7439-89-6	99.777	1.0	3541.48484	mg	
Material	2	Shell-Ni plating				1.0	0.6	mg	
Substance	3	Nickel	Nickel	7440-02-0	100.0	1.0	0.6	mg	
Material	2	Cover				1.0	80.0	mg	
Substance	3	1,4- Benzenedicarb oxylic acid, 1,4- dimethyl ester, polymer with 1,4-butanediol	Supplier	30965-26-5	40.0	1.0	32.0	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	30.0	1.0	24.0	mg	
Substance	3	Carbon black	Supplier	1333-86-4	3.0	1.0	2.4	mg	
Substance	3	Phenol, 4,4-(1- methylethylide ne)bis[2,6- dibromo- polymer with 2,2-[(1- methylethylide ne)bis[(2,6- dibromo-4,1- phenylene)oxy methylene]]bis[oxirane]	Supplier	68928-70-1	20.0	1.0	16.0	mg	
Substance	3	Antimony oxide (Sb2O3)	Supplier	1309-64-4	7.0	1.0	5.6	mg	
Material	2	Contact				1.0	49.4	mg	
Substance	3	Copper	Supplier	7440-50-8	65.14	1.0	32.17916	mg	
Substance	3	Iron	Supplier	7439-89-6	0.0070	1.0	0.003458	mg	
Substance	3	Zinc	Supplier	7440-66-6	34.851	1.0	17.21639	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0020	1.0	9.88E-4	mg	
Material	2	Housing				1.0	400.0	mg	
Substance	3	1,4- Benzenedicarb oxylic acid, 1,4- dimethyl ester, polymer with 1,4-butanediol	Supplier	30965-26-5	43.0	1.0	172.0	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	30.0	1.0	120.0	mg	
Substance	3	Antimony oxide (Sb2O3)	Supplier	1309-64-4	7.0	1.0	28.0	mg	

Substance	3	Phenol, 4,4-(1-methylethylidene)bis[2,6-dibromo-, polymer with 2,2-[(1-methylethylidene)bis(2,6-dibromo-4,1-phenylene)oxy methylene]]bis[oxirane]	Supplier	68928-70-1	20.0	1.0	80.0	mg	
Material	2	Contact-Au plating				1.0	0.3	mg	
Substance	3	Gold	Supplier	7440-57-5	100.0	1.0	0.3	mg	
Material	2	Contact-Pd-Ni plating				1.0	0.3	mg	
Substance	3	Nickel	Nickel	7440-02-0	20.0	1.0	0.06	mg	
Substance	3	Palladium	Supplier	7440-05-3	80.0	1.0	0.24	mg	
Sub-Item	1	LABEL, 25.4X35.05MM				1.0	50.0	mg	
Material	2	PS Adhesive Materials				1.0	35.0	mg	
Substance	3	Water	Supplier	7732-18-5	1.0	1.0	0.35	mg	
Substance	3	Poly(oxy-1,2-ethanedioxy carbonyl-1,4-phenylene carbonyl)	Supplier	25038-59-9	26.0	1.0	9.1	mg	
Substance	3	2-Propenoic acid, polymer with butyl 2-propenoate, 2-ethylhexyl 2-propenoate and methyl 2-propenoate	Supplier	98060-25-4	14.0	1.0	4.9	mg	
Substance	3	Pulp, cellulose	Supplier	65996-61-4	58.0	1.0	20.3	mg	
Substance	3	Siloxanes and Silicones, di-Me, vinyl group-terminated	Supplier	68083-19-2	1.0	1.0	0.35	mg	
Material	2	Ink				1.0	15.0	mg	
Substance	3	Cyclosiloxanes, di-Me	Supplier	69430-24-6	30.0	1.0	4.5	mg	
Substance	3	Rutile (TiO2)	Supplier	1317-80-2	30.0	1.0	4.5	mg	
Substance	3	Cyclohexanone	Supplier	108-94-1	20.0	1.0	3.0	mg	
Substance	3	2-Propenoic acid	Supplier	79-10-7	20.0	1.0	3.0	mg	